

CBR-SMD RF COG, Ceramic, 2.3 pF, +/-0.1 pF, 250 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Dimensions	
Chip Size	0603
L	1.6mm +/-0.1mm
W	0.8mm +/-0.1mm
T	0.8mm +/-0.07mm
B	0.4mm +/-0.15mm

Packaging Specifications	
Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	4000

General Information	
Series:	CBR-SMD RF COG
Style:	SMD Chip
Description:	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features:	Ultra High Q, Low ESR, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Notes:	Solder Wave or Solder Reflow.
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	2.3 pF
Capacitance Tolerance:	+/-0.1 pF
Voltage DC:	250 VDC
Dielectric Withstanding Voltage:	500 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Dissipation Factor:	0.224%
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	10 GOhms
Quality Factor:	446

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.